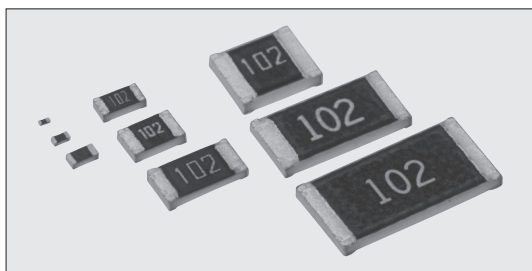


THICK FILM (GENERAL PURPOSE)

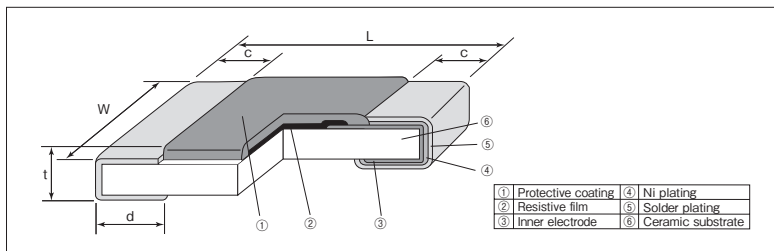


RK73B Flat Chip Resistors



Coating color : Black

Construction



Features

- Wide lineup from 01005 to 2512 size.
- Excellent heat resistance and weather resistance are ensured by the use of metal glaze thick film.
- Suitable for both flow and reflow solderings.
- Products with lead free termination meet EU-RoHS requirements. EU-RoHS regulation is not intended for Pb-glass contained in electrode, resistor element and glass.
- AEC-Q200 Tested (Exemption 1F).

Reference Standards

IEC 60115-8
JIS C 5201-8
EIAJ RC-2134C

Type Designation

Example

| RK73B | 2B | | T | TD | 103 | J |
|--------------|---|---|--|---|--------------------|----------------------|
| Product Code | Power Rating | Characteristic | Terminal Surface Material | Taping | Nominal Resistance | Resistance Tolerance |
| | 1F : 0.03W 1H : 0.05W 1E : 0.1W 1J : 0.1W 1.125W 2A : 0.25W 2B : 0.25W 2E : 0.5W W2H : 0.75W W3A : 1W W3A2 : 2W ^{※4} | Nil : Standard NEW A : Heat shock resistance ^{※2} | T : Sn G : Au ^{※3} (L : Sn/Pb ^{※4}) | TX : 4mm width-1mm pitch plastic embossed TBL : TC · TCM : 2mm pitch press paper TPL : TP : 2mm pitch punch paper TD : 4mm pitch punch paper TE : 4mm pitch plastic embossed BK : Bulk | 3 digits | G : ±2% J : ±5% |

※1 RK73B 2H, 3A and 3A2 are also still available (different "d" dimensions=0.4^{+0.2}_{-0.1}mm)

※2 With type A only T is available as the terminal surface material.
※3 Products with gold plated electrodes are also available with 1E, 1J and 2A types (10Ω~1MΩ), so please consult with us.
※4 With type 1F, 1H, W2H, W3A, W3A2 only T is available as the terminal surface material.
The terminal surface material lead free is standard.
Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS.
For further information on taping, please refer to APPENDIX C on the back pages.

Ratings

| Type | Power Rating | Rated Ambient Temp. | Rated Terminal Part Temp. | T.C.R. (×10 ⁻⁶ /K) | Resistance Range (Ω) | | Max. Working Voltage | Max. Overload Voltage | Packaging & Q'ty/Reel (pcs) | | | | | |
|------|--------------------|---------------------|---------------------------|----------------------------------|----------------------|-------------|----------------------|-----------------------|-----------------------------|--------|-----------------------------|-----------------------------|-------|---------------------|
| | | | | | G : ±2% E24 | J : ±5% E24 | | | TX | TBL | TC·TCM | TPL·TP | TD | TE |
| 1F | 0.03W | 70°C | — | ±200 | 100k~1M | 100k~10M | 20V | 30V | 40,000 | 20,000 | — | — | — | — |
| 1H | 0.05W | 70°C | 125°C | ±250 | 10~91k | 10~91k | 25V | 50V | — | — | TC : 10,000 TCM : 15,000 | — | — | — |
| 1E | 0.1W | 70°C | 125°C | ±200 | 1~10M | 1~10M | 75V | 100V | — | — | — | TPL : 20,000 TP : 10,000 | — | — |
| 1J | 0.1W | 70°C | 125°C | ±200 | 1.1k~10M | 1.1k~10M | | | — | — | — | TP : 10,000 | 5,000 | — |
| 2A | 0.25W | 70°C | 125°C | ±200 | 1~1M | 1~1M | 150V | 200V | — | — | — | TP : 10,000 | 5,000 | 4,000 ^{※6} |
| 2B | 0.25W | 70°C | 125°C | ±200 | 1~5.6M | 1~5.6M | | | — | — | — | — | 5,000 | 4,000 ^{※6} |
| 2E | 0.5W | 70°C | 125°C | ±200 | 6.2M~10M | 6.2M~22M | 200V | 400V | — | — | — | — | 5,000 | 4,000 ^{※6} |
| W2H | 0.75W | 70°C | 125°C | ±200 | 10~5.6M | 1~5.6M | | | — | — | — | — | — | 4,000 |
| W3A | 1.0W | 70°C | 125°C | ±200 | 10~5.6M | 1~5.6M | 200V | 400V | — | — | — | — | — | 4,000 |
| W3A2 | 2.0W ^{※5} | 70°C | 95°C | ±200 | 10~5.6M | 1~5.6M | | | — | — | — | — | — | 4,000 |

Operating Temperature Range : -55°C ~ +125°C (1F), -55°C ~ +155°C (1H · 1E · 1J · 2A · 2B · 2E · W2H · W3A · W3A2)

Rated voltage = √(Power Rating × Resistance value) or Max. working voltage, whichever is lower.

For flat chip jumper resistor, please refer to RK73Z series.

※5 If you use at the rated power, please keep the condition that the terminal of the resistor is below the rated terminal part temperature. Please refer to the derating curves based on the terminal temperature of right side on the next page.

※6 Standard packaging : TD(4mm pitch punch paper)

If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature".

For more details, please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog.

While using under high power, the temperature of the product may increase depending on the condition of heat dissipation from PCB.

Be sure to check the terminal part temperature as well as precautions to use on delivery specifications before use.

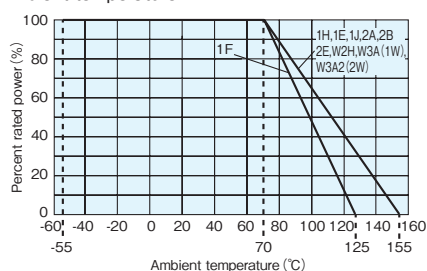
Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.
Contact our sales representatives before you use our products for applications including automobiles, medical equipment and aerospace equipment.
Malfunction or failure of the products in such applications may cause loss of human life or serious damage.

Jun. 2021

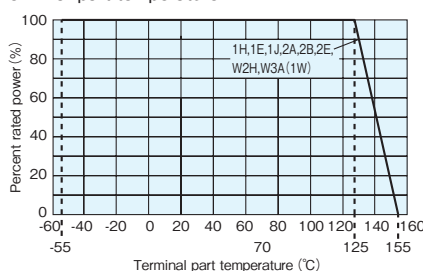
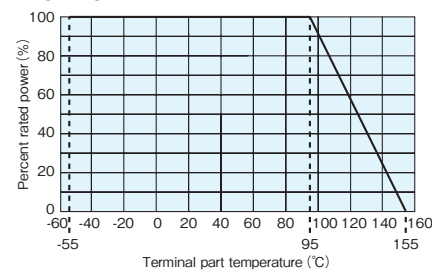
www.koaglobal.com

Derating Curve

Ambient temperature



Terminal part temperature


Terminal part temperature
RK73B W3A2


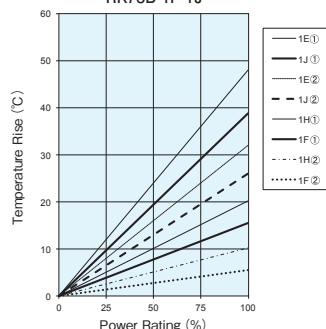
For resistors operated at an ambient temperature of 70°C or higher, the power shall be derated in accordance with the above derating curve.

When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve.

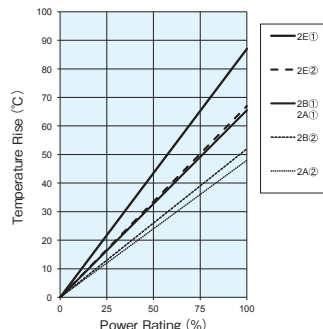
※Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

Temperature Rise

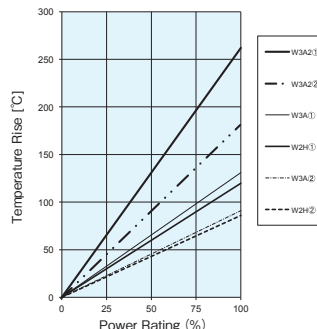
RK73B 1F-1J



RK73B 2A-2E

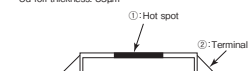


RK73B W2H-W3A2



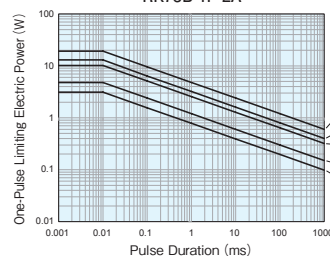
Regarding the temperature rise, the value of the temperature varies per conditions and board for use since the temperature is measured under our measuring conditions.

Measurement condition
Room temperature: 25°C
PCB: FR-4t = 1.6mm
Cu foil thickness: 35μm

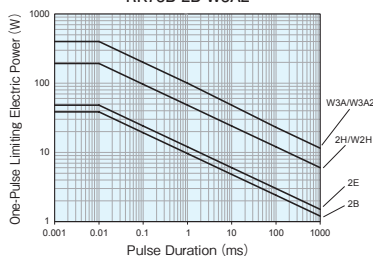


One-Pulse Limiting Electric Power

RK73B 1F-2A



RK73B 2B-W3A2



The maximum applicable voltage is equal to the max. overload voltage. Please ask us about the resistance characteristic of continuous applied pulse. The pulse endurance values are not assured values, so be sure to check the products on actual equipment when you use them.

Performance

| Test Items | Performance Requirements $\Delta R \pm (\% + 0.1 \Omega)$ | | Test Methods |
|--|--|--|---|
| | Limit | Typical | |
| Resistance | Within specified tolerance | — | 25°C |
| T.C.R. | Within specified T.C.R. | — | +25°C/−55°C and +25/+125°C |
| Overload (Short time) | 2 | 1 : 1F 0.5 : others | Rated voltage $\times 2.5$ for 5s (1E, 2B, W3A2 : Rated voltage $\times 2$ for 5s) |
| Resistance to soldering heat | 1 : 1F~W3A2 ($10 \Omega \leq R \leq 1M \Omega$) 3 : 1F~W3A2 ($R < 10 \Omega$, $R > 1M \Omega$) | 0.5 : 1F~W3A2 ($10 \Omega \leq R \leq 1M \Omega$) 1 : 1F~W3A2 ($R < 10 \Omega$, $R > 1M \Omega$) | 260°C $\pm 5^\circ\text{C}$, 10s $\pm 1\text{s}$ |
| Rapid change of temperature | 1 : 1F, Characteristic [A] (Heat shock resistance) 0.5 : others | 0.5 : 1F, Characteristic [A] (Heat shock resistance) 0.3 : others | Characteristic [Ni] (Standard) : −55°C (30min.) / +125°C (30min.) 100 cycles Characteristic [A] (Heat shock resistance) : −55°C (30min.) / +125°C (30min.) 1000 cycles |
| Moisture resistance | 2 : 1J, 2A, 2B 3 : others | 0.75 : 1J, 2A, 2B 1.5 : 1F 1 : others | 40°C $\pm 2^\circ\text{C}$, 90%~95%RH, 1000h 1.5h ON/0.5h OFF cycle |
| Endurance at 70°C or rated terminal part temperature | 2 : 1J, 2A, 2B 3 : others | 0.75 : 1J, 2A, 2B 1 : others | 70°C $\pm 2^\circ\text{C}$ or rated terminal part temperature $\pm 2^\circ\text{C}$ 1000h 1.5h ON/0.5h OFF cycle |
| High temperature exposure | 1 | 0.5 : 1F 0.3 : others | +125°C, 1000h : 1F +155°C, 1000h : 1H, 1E, 1J, 2A, 2B, 2E, W2H, W3A, W3A2 |

Precautions for Use

- The substrate of chip resistors is alumina. Cracks may occur at the connection of solder (solder fillet portion) due to the difference of the coefficient of thermal expansion from a mounting board when heat stress like heat cycle, etc. are repeatedly given to them. Care should be taken to the occurrence of the cracks when the change in ambient temperature or ON/OFF of load is repeated, especially when large types of W2H/W3A/W3A2 which have large thermal expansion and also self heating. By general temperature cycle test using glass-epoxy (FR-4) boards under the maximum/minimum temperatures of operating temperature range, the crack does not occur easily in the types of 1F~2E, but the crack tends to occur in the types of W2H/W3A/W3A2. The occurrence of the crack by heat stress may be influenced by the size of a pad, solder volume, heat radiation of mounting board etc., so please pay careful attention to designing when a big change in ambient temperature and conditions for use like ON/OFF of load can be assumed.
- Care should be taken that RK73B1F may be damaged when static electricity occurs and is applied in the equipment assembly process.